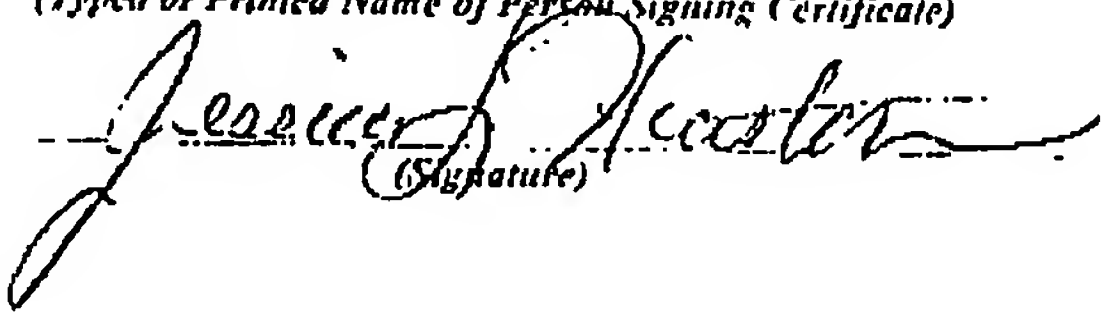


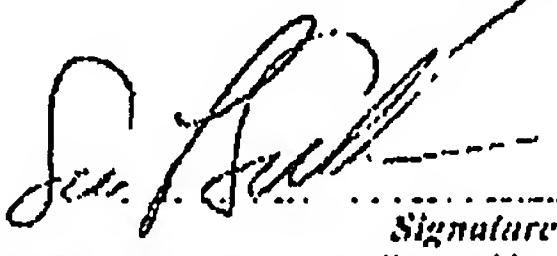
<b>CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)</b>			Docket No. FIS920030278US1	
Applicant(s): TIEN-JEN CHANG ET AL.				
Application No. 10/707,047	Filing Date 11/18/2003	Examiner L. VAN	Group Art Unit 1753	
Invention: METHOD FOR SELECTIVE ELECTRO-PLATING OF SEMICONDUCTOR DEVICE I/O PADS USING A TITANIUM-TUNGSTEN SEED LAYER				
<b>RECEIVED</b> <b>CENTRAL FAX CENTER</b> <b>JAN 04 2006</b>				
I hereby certify that this <u>Transmittal and Amendment</u> (Identify type of correspondence) is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>571-273-8300</u> ) on <u>01/04/2006</u> (Date)				
<u>Jessica L. Huston</u> (Typed or Printed Name of Person Signing Certificate)  (Signature)				
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P. 02/09

<b>AMENDMENT TRANSMITTAL LETTER (Large Entity)</b>					Docket No. <b>FIS920030278US1</b>	
Applicant(s): <b>TIEN-JEN CHIANG ET AL.</b>						
Application No. <b>10/707,047</b>	Filing Date <b>11/18/2003</b>	Examiner <b>L. VAN</b>	Customer No. <b>29371</b>	Group Art Unit <b>1753</b>	Confirmation No. <b>1046</b>	
Invention: <b>METHOD FOR SELECTIVE ELECTRO-PLATING OF SEMICONDUCTOR DEVICE I/O PADS USING A TITANIUM-TUNGSTEN SEED LAYER</b>						
<b>COMMISSIONER FOR PATENTS:</b>						
Transmitted herewith is an amendment in the above-identified application.						
The fee has been calculated and is transmitted as shown below.						
<b>CLAIMS AS AMENDED</b>						
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE	
TOTAL CLAIMS	14	20	0	x \$50.00	\$0.00	
INDEP. CLAIMS	2	3	0	x \$200.00	\$0.00	
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00	
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT</b>					<b>\$0.00</b>	
<input checked="" type="checkbox"/> No additional fee is required for amendment. <input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____ <input type="checkbox"/> A check in the amount of _____ to cover the filing fee is enclosed. <input checked="" type="checkbox"/> The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account <b>09-0458</b> <input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16. <input type="checkbox"/> Any patent application processing fees under 37 CFR 1.17. <input type="checkbox"/> Payment by credit card. Form PTO-2038.						
<b>WARNING:</b> Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.						
 _____ Signature			Dated: <b>January 4, 2006</b>			
Sean F. Sullivan Reg. No. 38,328 Cantor Colburn LLP 55 Griffin Road South Bloomfield, CT 06002 860-286-2929			I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on _____ _____ (Date) _____ Signature of Person Mailing Correspondence _____ Typed or Printed Name of Person Mailing Correspondence			
CC:						

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	TIEN-JEN CHIANG, ET AL.	)	
Serial No.:	10/707,047	)	Group Art Unit: 1753
Filed:	November 18, 2003	)	
For:	METHOD FOR SELECTIVE ELECTRO- PLATING OF SEMICONDUCTOR DEVICE I/O PADS USING A TITANIUM-TUNGSTEN SEED LAYER	)	Examiner: Van, L.
		)	Confirmation No.: 1046

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

In response to the Office Action mailed October 5, 2005, please amend the  
Application as follows: